

New Product

Vishay Siliconix

P-Channel 2.5-V (G-S) MOSFET

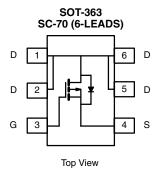
PRODUCT SUMMARY					
V _{DS} (V)	$r_{DS(on)}\left(\Omega\right)$	I _D (A)			
- 25	0.180 at V _{GS} = - 4.5 V	± 1.5			
	0.200 at V _{GS} = - 3.6 V	± 1.4			
	0.265 at V _{GS} = - 2.5 V	± 1.2			

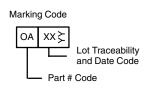
FEATURES

• TrenchFET® Power MOSFET



RoHS'





Ordering Information: Si1403DL-T1

Si1403DL-T1-E3 (Lead (Pb)-free)

Parameter		Symbol	5 Sec	Steady State	Unit
Drain-Source Voltage		V_{DS}	- 20		V
Gate-Source Voltage	V _{GS} ± 12		± 12		
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	- I _D	± 1.5	± 1.4	Α
	T _A = 85 °C		± 1.2	± 1.0	
Pulsed Drain Current		I _{DM}	± 5		A
Continuous Diode Current (Diode Conduction) ^a		I _S	- 0.8	- 0.8	
Maximum Power Dissipation ^a	T _A = 25 °C	P _D	0.625	0.568	W
	T _A = 85 °C		0.400	0.295	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^a	t ≤ 5 sec	R _{thJA}	165	200		
	Steady State		180	220	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	105	130		

Notes:

a. Surface mounted on 1" x 1" FR4 board.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply.

Vishay Siliconix

New Product



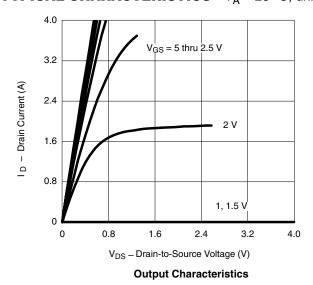
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
Static		•	•	•		•	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.6		- 1.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 20 V, V _{GS} = 0 V			- 1	μΑ	
		V _{DS} = - 20 V, V _{GS} = 0 V, T _J = 85 °C			- 5		
On-State Drain Current ^a	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 4.5 V	- 2			Α	
Drain-Source On-State Resistance ^a		V _{GS} = - 4.5 V, I _D = - 1.5 A		0.145	0.180	Ω	
	r _{DS(on)}	V _{GS} = - 3.6 V, I _D = - 1.4 A		0.165	0.200		
		V _{GS} = - 2.5 V, I _D = - 0.8 A		0.220	0.265		
Forward Transconductance ^a	9 _{fs}	V _{GS} = - 10 V, I _D = - 1.5 A		3.8		S	
Diode Forward Voltage ^a	V _{SD}	I _S = - 0.8, V _{GS} = 0 V		- 0.78	- 1.1	V	
Dynamic ^b		•		•			
Total Gate Charge	Qg			3.7	4.5		
Gate-Source Charge	Q_{gs}	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -1.5 \text{ A}$		0.9		nC	
Gate-Drain Charge	Q _{gd}			0.9		İ	
Turn-On Delay Time	t _{d(on)}			8	12		
Rise Time	t _r	$V_{DD} = -10 \text{ V}, R_L = 10 \Omega$		25	40		
Turn-Off DelayTime	t _{d(off)}	$I_D \cong$ - 1 A, V_{GEN} = - 4.5 V, R_G = 6 Ω		21	32	ns	
Fall Time	t _f	7		20	30		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 0.8 A, di/dt = 100 A/μs		20	40	1	

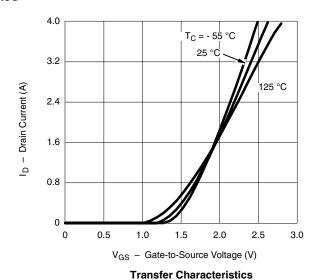
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS $T_A = 25 \, ^{\circ}\text{C}$, unless noted

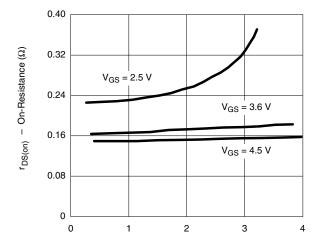






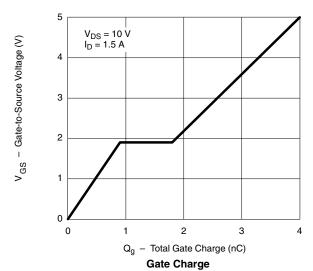
New Product

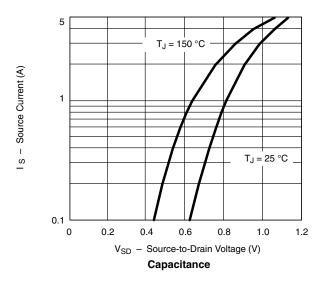
TYPICAL CHARACTERISTICS $T_A = 25\ ^{\circ}C,$ unless noted

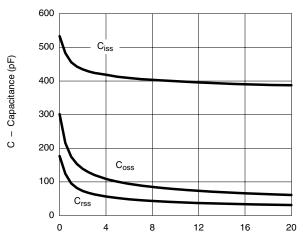


I_D - Drain Current (A)

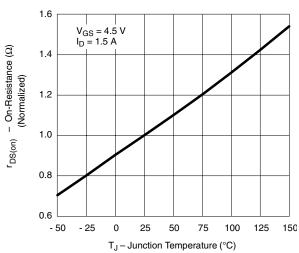
On-Resistance vs. Drain Current



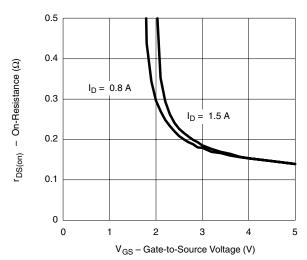




V_{DS} - Drain-to-Source Voltage (V) **Capacitance**



On-Resistance vs. Junction Temperature



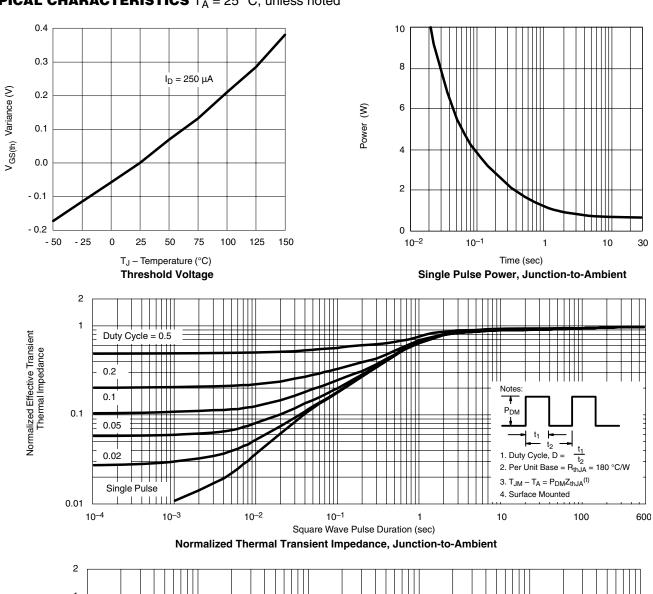
On-Resistance vs. Gate-to-Source Voltage

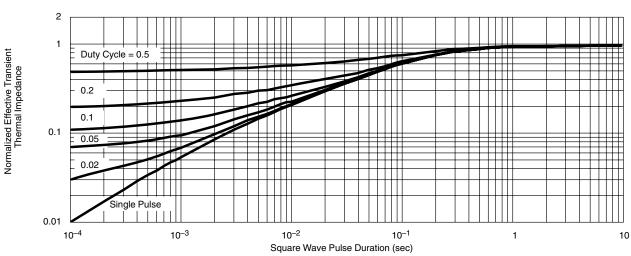
Vishay Siliconix

New Product



TYPICAL CHARACTERISTICS $T_A = 25$ °C, unless noted





Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?71072.



Vishay

Disclaimer

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.

Revision: 18-Jul-08

Document Number: 91000 www.vishay.com